



Volume 9 Number 2

April 1995

# AI EDAM

**Artificial Intelligence for Engineering Design, Analysis and Manufacturing**

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**Clive L. Dym, Editor**

**CAMBRIDGE  
UNIVERSITY PRESS**

ISSN 0890-0604



Artificial Intelligence for  
Engineering Design,  
Analysis and Manufacturing

(ISSN 0890-0604)

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**Editorial Office:** Clive L. Dym, Editor, *AI EDAM: Artificial Intelligence for Engineering Design, Analysis and Manufacturing*, Department of Engineering, Harvey Mudd College, Claremont, CA 91711, USA. Telephone: (909) 621-8853. Fax: (909) 621-8967. E-mail: Clive\_Dym@hmc.edu.

**Book Reviews Office:** David C. Brown, Book Review Editor, Department of Computer Science, Worcester Polytechnic Institute, Worcester, MA 01609. Phone: (508) 831-5618. Fax: (508) 831-5776. E-mail: dcb@owl.wpi.edu.

**Publishing, Subscription and Advertising Offices:** Cambridge University Press, 40 West 20th Street, New York, NY 10011, USA; and (outside the US and Canada) Cambridge University Press, The Edinburgh Building, Shaftesbury Road, Cambridge CB2 2RU, England.

**Published Quarterly.** Annual institutional subscription rates: US \$192.00 in the US, Canada, and Mexico; UK £109.00 + VAT elsewhere. Individual rates: US \$85.00 in the US, Canada, and Mexico; UK £48.00 + VAT elsewhere. Single part rates: US \$43.00 in the US, Canada, and Mexico; UK £24.00 + VAT elsewhere. Prices include postage and insurance.

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Printed in the United States of America.

Second class permit pending at New York, NY, and additional mailing offices. Postmaster: send address changes in the US, Canada, and Mexico to: *AI EDAM: Artificial Intelligence for Engineering Design, Analysis and Manufacturing*, Journals Department, Cambridge University Press, 110 Midland Avenue, Port Chester, NY 10573-4930.



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VOLUME 9

APRIL 1995

NUMBER 2

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